

Intel® Edison Board Support Package

User Guide

May 2015

Revision 006



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Revision History

Revision	Description	Date
ww26	Initial release.	July 7, 2014
ww32	Improved section about adding external recipes.	August 4, 2014
ww36	Corrected code example in chapter 4.	September 5, 2014
001	First public release.	September 9, 2014
002	Corrected file names and file paths in section 3.3.	November 21, 2014
003	Minor corrections.	December 1, 2014
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005	Added chapter on using the make command to build images; minor corrections.	February 4, 2015
006	Updated commands, based on the latest meta-intel-edison repository.	May 1, 2015





Introduction

This document is for software and system engineers who are building and customizing images, kernels, and native SDKs for the Intel® Edison Development Platform. Precompiled versions of the BSP are available on the Intel website. Users who don't want to modify the default images don't need to read this document.

The Intel® Edison Board Support Package offers these features:

- Kernel image based on Linux kernel 3.10.17
- U-boot second stage bootloader
- Bluetooth and Wi-Fi connectivity
- Intel cloud connectivity middleware
- Many base Linux packages provided by the Yocto project

1.1 The Yocto Project

The standard Linux* OS shipped on the Intel® Edison platform is based on Yocto. The Yocto Project is an open source collaboration project that provides templates, tools, and methods to help you create custom Linux-based systems for embedded products.

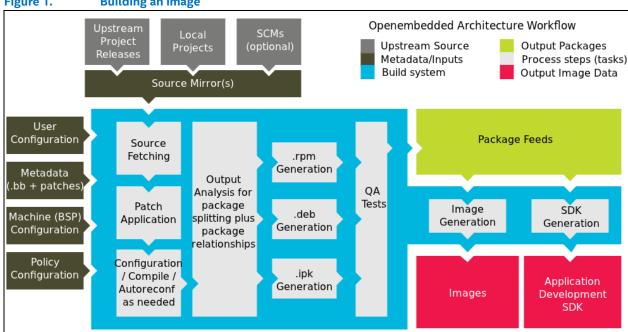


Figure 1. **Building an image**

The Intel® Edison BSP source package is the set of Yocto source files necessary to generate a Linux image ready to run on the Intel® Edison board. It contains:

- The set of Yocto recipes describing the process for building a Linux kernel, a bootloader, and a rootfs, which together form the bootable images ready to flash on a device.
- The set of Yocto recipes necessary for creating a Software Developer Kit (SDK) and a cross-compiling tool chain that developers can use to create native applications for Intel® Edison.

For details on the Yocto project, consult the documentation on the Yocto website. (See section 1.2.) Note:



1.2 References

Reference	Name	Number/location
331188	Intel® Edison Board Support Package User Guide	(This document)
331189	Intel® Edison Compute Module Hardware Guide	http://www.intel.com/support/edison/sb/CS-035274.htm
331190	Intel® Edison Breakout Board Hardware Guide	http://www.intel.com/support/edison/sb/CS-035252.htm
331191	Intel® Edison Kit for Arduino* Hardware Guide	http://www.intel.com/support/edison/sb/CS-035275.htm
331192	Intel® Edison Native Application Guide	http://www.intel.com/support/edison/sb/CS-035382.htm
329686	Intel® Galileo and Intel® Edison Release Notes	https://communities.intel.com/docs/DOC-23388
332032	Intel® Edison Software Release Notes	
[GSG]	Intel® Edison Getting Started Guide	W: https://communities.intel.com/docs/DOC-23147 M: https://communities.intel.com/docs/DOC-23148 L: https://communities.intel.com/docs/DOC-23149
331438	Intel® Edison Wi-Fi Guide	http://www.intel.com/support/edison/sb/CS-035380.htm
331704	Intel® Edison Bluetooth* Guide	http://www.intel.com/support/edison/sb/CS-035381.htm
332434	Intel® Edison Audio Setup Guide	
[YPQSG]	Yocto Project Quick Start Guide	http://www.yoctoproject.org/docs/current/yocto-project-qs/yocto-project-qs.html
[YDM]	Yocto Developer Manual	http://www.yoctoproject.org/docs/current/dev-manual /dev-manual.html
[YKDM]	Yocto Kernel Developer Manual	http://www.yoctoproject.org/docs/latest/kernel-dev /kernel-dev.html

1.3 Terminology

Term	Definition
SSH	Secure shell
FTP	File Transfer Protocol
GDB	GNU debugger



2 Build an Intel® Edison Image using bitbake

Building a standard Intel® Edison image requires downloading and installing several prerequisite packages. These instructions are valid for a recent Ubuntu Linux* distribution and should be valid for other distributions with minor changes.

Note: Make sure your working directory is not part of an encrypted file system, such as **eCryptFS**. Because encrypted file systems restrict file length, the build will fail.

To build a standard Intel® Edison image, do the following:

1. Install the prerequisite packages with the following command:

```
sudo apt-get install build-essential git diffstat gawk chrpath texinfo
libtool gcc-multilib
```

2. Download the BSP source package edison-src.tgz from the Intel® Edison Software Downloads page. The package includes the full Yocto environment, and Intel® Edison-specific Yocto recipes to build the image (including the Linux kernel), a bootloader, and all necessary packages. Download the BSP source package to your working directory and decompress it.

```
tar xvf edison-src.tgz
cd edison-src/
```

3. Use the setup.sh script to initialize the build environment for Intel® Edison.

To create download and sstate directory, you can use mkdir command:

```
mkdir bitbake_download_dir
mkdir bitbake_sstate_dir
```

```
./meta-intel-edison/setup.sh --dl_dir=<=/<path_to>/bitbake_download_dir
--sstate dir=<=/<path to>/bitbake sstate dir
```

Optionally, you can move your download and build cache (also called *sstate*) directories from the default location under the build directory, using the --dl_dir and --sstate_dir options. Doing this will make it easier to share this data between build environments, and allow much faster build and download time when rebuilding the full image, even after a full manual cleanup (by means of deleting everything under your build directory). To create the *sstate* directory, use the *mkdir* command:

```
mkdir bitbake_download_dir
mkdir bitbake sstate dir
```

4. Configure the shell environment with the *source* command below. After the command executes, the directory changes to the *edison-src/build* folder.

```
source poky/oe-init-build-env
```

5. Now you are ready to build the full Intel® Edison image with the bitbake command:

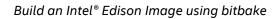
```
bitbake edison-image
```

Building all the packages from scratch can take up to 5 or 6 hours, depending on your host. After the first build (provided you have not done any major cleanups), you can expect much faster rebuilds, depending on your host and the amount of changes. When the bitbake process completes, images to flash are created in the *edison-src/build/tmp/deploy/images/edison* directory. To simplify the flash procedure, run the script below to copy the necessary files to the *build/toFlash* directory.

```
../meta-intel-edison/utils/flash/postBuild.sh
```

The images are ready to flash on the Intel® Edison Development Board. Refer to the [GSG] for details on the flashing procedure.

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2.1 Build the Intel® Edison native SDK

To cross-compile native applications for your image, you must generate an SDK containing a cross-compiler toolchain and sysroot. You can generate a full SDK for the Intel® Edison Development Board with the following command:

bitbake edison-image -c populate sdk

This bitbake command creates the SDK installer script:

ls tmp/deploy/sdk

poky-edison-eglibc-x86 64-edison-image-core2-32-toolchain-1.6.1.sh

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3 Build an Intel® Edison Image with make

The Intel® Edison source also supports Makefile-based builds, which allows you to build a standard Intel® Edison image with the *make* command. To build a standard image with the *make* command, do the following:

1. Install the prerequisite packages (if you have not already done so) with the following command:

 $\verb|sudo| apt-get| in stall build-essential git diffstat gawk chrpath texinfo \\ libtool gcc-multilib|$

Download the BSP source package edison-src.tgz from the Intel® Edison Software Downloads page. The
package includes the full Yocto environment, and Intel® Edison-specific Yocto recipes to build the image
(including the Linux kernel), a bootloader, and all necessary packages. Download the BSP source package
to your working directory and decompress it.

tar xvf edison-src.tgz
cd edison-src/

3. To configure the Yocto build environment, enter the following command:

make setup

This command automatically creates *download* and *sstate* directories in the *bbcache* directory. You can override the value for the download cache directory or specify the number of threads to use for compilation (to speed up build time) by editing the Yocto configuration file *local.conf*. This file is in <*edison-src>/out/linux64/build/conf/local.conf*.

4. When the setup is ready, you can build the full Intel® Edison image with the make command:

make image

You will find the images in the <edison-src>/out/current/build/toFlash directory.

5. Flash the images:

make flash

To get help on available commands, enter the following:

make help



Build the Intel® Edison native SDK with the make command 3.1

To cross-compile native applications for your image, you must generate an SDK containing a cross-compiler toolchain and sysroot. You can generate a full SDK for the Intel® Edison Development Board with the following command:

```
make sdk
```

This make command creates the SDK installer script in <edison-src>/out/current/build/tmp/deploy/sdk:

```
ls out/current/build/tmp/deploy/sdk/
poky-edison-eglibc-x86 64-edison-image-core2-32-toolchain-1.6.1.sh
```

Execute the cross-compiler script to install the toolchain.

You can still use the bitbake command if you used make for basic setup as described above. In order to use the bitbake, go to the <edison-src>/out/current/ directory and configure the shell environment with the source command, as shown below.

```
$ cd out/current
$ source poky/oe-init-build-env
```

After the command executes, the directory changes to the edison-src/out/linux64/build folder.

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4 Creating Custom Intel® Edison Images

This section explains how to customize standard Linux* images for the Intel® Edison platform.

4.1 Adding standard Yocto packages in the image

Yocto comes with a large set of recipes allowing you to simply add packages to our image. The available packages are on http://packages.yoctoproject.org. In order to add a package to our image, you simply need to add it to the IMAGE_INSTALL variable. For example, if you want to add the lib PNG to the image, add the following line to the edison-image.bb file:

```
IMAGE_INSTALL += "libpng"
```

Rebuild the image to have libpng included in it.

Note: If you need to add patches to existing upstream sources, consult the Yocto documentation [YDM].

4.2 Excluding packages from the image

To exclude unnecessary packages from the image, remove the matching entry from the *IMAGE_INSTALL* variable (see section 4.1) or add the package name to the *PACKAGE_EXCLUDE* variable in the *build/conf/local.conf* file.

```
PACKAGE_EXCLUDE = "package1 package2"
```

4.3 Add third-party packages to the image

If Yocto does not provide a package you need, chances are good that someone else has created a Yocto recipe for it. In this section, we will add a set of Yocto recipes (from meta-openembedded, a third-party Yocto layer) to the Intel® Edison source. The recipes contained in this layer allow you to add many packages in a custom Intel® Edison image. Download the meta-openembedded layer at: https://github.com/openembedded/meta-openembedded. As an example, the opencv library will be added to the image. The example assumes a standard image has been created by running the setup.sh script and bitbake edison-image as described in the previous sections.

1. Get the OpenEmbedded Yocto layer collection from GitHub. We use the "daisy" branch matching the version of Yocto that is used by the Intel® Edison software.

```
cd edison-src/meta-intel-edison
git clone https://github.com/openembedded/meta-openembedded.git
cd meta-openembedded
git checkout daisy
```

2. Tell bitbake to look for recipes contained in the new meta-openembedded layer. Edit the edison-src /build/conf/bblayers.conf file and append the path to the new layer into the BBLAYERS variable:

```
BBLAYERS ?= " \
  [..]
Full/path/to/edison-src/meta-intel-edison/meta-openembedded/
  meta-openembedded \ "
```

3. You now can add any recipe provided by the new *meta-oe* layer to your image. As in section 4.1, to add opency to the image, add it to the *IMAGE_INSTALL* variable. You can do this in the *edison-src/meta-intel-edison/meta-intel-edison-distro/recipes-core/images/edison-image.bb* file, for example. In the particular case of *opency*, to avoid bringing too many dependencies, you should also redefine a specific variable so that the library is built without *gtk* support:

```
IMAGE_INSTALL += "opency"
PACKAGECONFIG_pn-opency="eigen jpeg libav png tiff v41"
```



4. Save the file and rebuild the image as follows:

```
cd edison-src
source poky/oe-init-build-env
bitbake edison-image
```

Write a Yocto recipe from scratch

It is also possible to create your own Yocto recipes from scratch and add them to the image. This section describes the required steps to add a hello_world C program to our image. The GNU hello_world is a real project that you can download from http://ftp.gnu.org/gnu/hello/hello-2.7.tar.gz.

1. The first step is to tell bitbake where to download the code, and how to build the package. This is done by adding a new recipe (.bb) file in the right directory. To do this, create the recipe file hello 2.7.bb in the edison-src/meta-intel-edison/meta-intel-edison-distro/recipes-support/hello directory, with the following content:

```
DESCRIPTION = "GNU Helloworld application"
LICENSE = "GPLv3+"
LIC FILES CHKSUM ="file://COPYING; md5=d32239bcb673463ab874e80d47fae504"
SRC URI = "${GNU MIRROR}/hello/hello-${PV}.tar.gz"
SRC_URI[md5sum] = "fc01b05c7f943d3c42124942a2a9bb3a"
inherit autotools gettext
```

As the hello_world project makes use of the autotools, it is enough to inherit the autotool Yocto Note: class to tell bitbake how to configure and build the project. Refer to the [YDM] for details on the .bb syntax.

The hello world recipe is ready, but you still need to add it to your image. To do so, add the following line to the edison-src /meta-intel-edison/meta-intel-edison-distro/recipes-core/images/edison-image.bb file:

```
IMAGE INSTALL += "hello"
```

3. Then rebuild the image:

bitbake edison-image

Add a recipe for a systemd service 4.5

Developers may choose to add their own application as a service to Intel® Edison. On the Intel® Edison platform, services are special applications that run in the background. They are managed by systemd, a system and service manager for Linux*.

A systemd service is described by a .service file that needs to be deployed on the Intel® Edison board usually in /lib/systemd/system. This service file contains information on how and when to start the service, which are its dependencies, etc.

Refer to systemd documentation http://www.freedesktop.org/wiki/Software/systemd for an overview of the Note: base systemd concepts, and a description of the associated tools.

The Intel® Edison BSP source includes a sample recipe for creating a systemd service application using Yocto. The sample is in the edison-src/meta-intel-edison/meta-intel-edison-distro/recipes-support/watchdog-sample folder.

A system service is described by a .service file. Refer to the sample file watchdog-sample.service at: http://www.freedesktop.org/software/systemd/man/systemd.service.html.

To deploy the service from a Yocto recipe, you need to inherit the Yocto systemd class. Refer to http://www.yoctoproject.org/docs/current/ref-manual/ref-manual.html#ref-classes-systemd.

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5 Customizing the Linux* Kernel

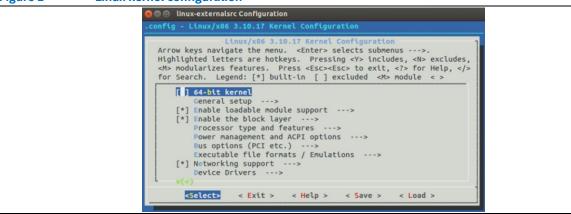
This chapter contains a brief overview of making kernel modifications. Customizing the kernel is important on embedded systems for making new devices and sensors. For more detailed information, see the [YKDM] at: http://www.yoctoproject.org/docs/latest/kernel-dev/kernel-dev.html. Check it out for additional ways of configuring the kernel, for example through using more compact and modular configuration fragments. The approach described here is good for ad-hoc modifications while config fragments are shorter than full kernel configuration, and it allows you to create and distribute your own Yocto recipes for modifying specific kernel features.

The base kernel config file is delivered with edison-src.tar.gz and is located in the edison-src/meta-inteledison/meta-intel-edison-bsp/recipes-kernel/linux/files/defconfig file.

The menuconfig tool provides an easy interactive method with which to define kernel configurations. For general information on menuconfig, see http://en.wikipedia.org/wiki/Menuconfig. The following command opens the menuconfig terminal for configurations:

bitbake virtual/kernel -c menuconfig

Figure 2 Linux kernel configuration



When the configuration is completed, replace *defconfig* with .config, then rename it back to *defconfig*. We also suggest taking a backup of the *defconfig* file. Force bitbake to copy the modified *defconfig* file to the actual build directory. Then the new image with modified kernel is ready to build.

```
cp <path_to_edison-src>/build/tmp/work/edison-poky-linux/linux-
yocto/3.10.17+gitAUTOINC+6ad20f049a_c03195ed6e-r0/linux-edison-standard-
build/.config <path_to_edison-src>/meta-intel-edison/meta-intel-edison-
bsp/recipes-kernel/linux/files/defconfig
```

We can also change the Intel® Edison kernel configuration (i386_edison_defconfig) file and overwrite with customized kernel configuration by doing following:

```
cp <path_to_edison-src>/build/tmp/work/edison-poky-linux/linux-
yocto/3.10.17+gitAUTOINC+6ad20f049a_c03195ed6e-r0/linux-edison-standard-
build/.config <path_to_edison-src>/build/tmp/work/edison-poky-linux/linux-
yocto/3.10.17+gitAUTOINC+6ad20f049a_c03195ed6e-
r0/linux/arch/x86/configs/i386_edison_defconfig

bitbake virtual/kernel -c configure -f -v
bitbake edison-image
```

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